



PATENT
0649-0791P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant:	YAMAGUCHI et al.	Conf.:	7851
Appl. No.:	09/901,662	Group:	1714
Filed:	July 11, 2001	Examiner:	K. WYROZEBSKI LEE
For:	MOLDING COMPOSITION		

RECEIVED
AUG 4 2003
TC 1700

REPLY UNDER 37 C.F.R. § 1.111

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

July 31, 2003

Sir:

In reply to the Office Action dated April 1, 2003, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

The amendments presented herein comply with the "Revised Amendment Format" as set forth in the Official Gazette Notice dated February 25, 2003. In accordance with the Notice, the provisions of 37 C.F.R. § 1.121(a)-(d) are waived.